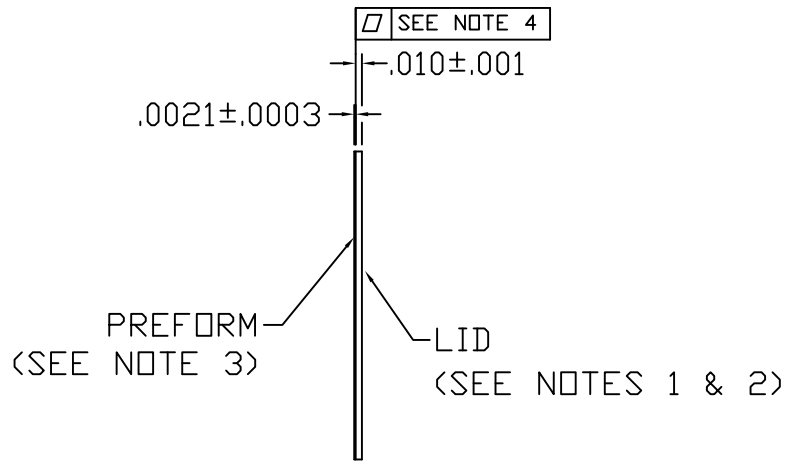
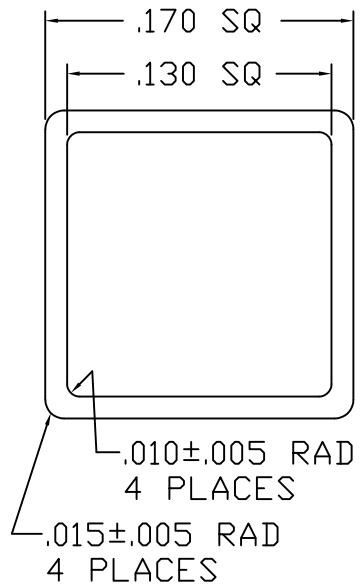


# SSM P/N CL-17002



**NOTES**

- 1. MAT'L : KOVAR OR ALLOY 42
- 2. PLATING : 1st LAYER 50/350 MICROINCHES NI  
               2nd LAYER Au  
               3rd LAYER 50/350 MICROINCHES NI  
               4th LAYER 25 MICROINCHES MINIMUM Au
- NOTES : TOTAL NICKEL LAYERS SHALL NOT EXCEED 450 MICROINCHES AND THE SUM OF BOTH GOLD LAYERS SHALL BE 50 MICROINCHES MINIMUM.
- 3. PREFORM - 80% ±1% Au  
               20% Sn
- 4. FLATNESS : ONE MIL (.001) MAXIMUM PER 1/2" T.I.R
- 5. TOLERANCES TO BE (XXX) 3 PLACES ±.002 UNLESS OTHERWISE NOTED

DESCRIPTION	
HI REL COMBO LID	
PART NO	
CL-17002	
Spectrum Semiconductor Materials, Inc. 155 Nicholson Lane San Jose, CA 95134 PH: (408) 435-5555 Fx: (408)435-8226	MFG WILLIAMS ADVANCED MATERIALS
	MFG DRAWING NO
	W217H

